

NEXCOM International Co., Ltd.

Industrial Computing Solutions Fan-less Computer NISE 3640M Series User Manual

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Preface

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Acknowledgements

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Regulatory Compliance Statements

This section provides the FCC compliance statement for Class B devices and describes how to keep the system CE compliant.

Declaration of Conformity

FCC

This equipment has been tested and verified to comply with the limits for a Class B digital device, pursuant to Part 15 of FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. Operation of this equipment in a residential area (domestic environment) is likely to cause harmful interference, in which case the user will be required to correct the interference (take adequate measures) at their own expense.

CE

The product(s) described in this manual complies with all applicable European Union (CE) directives if it has a CE marking. For computer systems to remain CE compliant, only CE-compliant parts may be used. Maintaining CE compliance also requires proper cable and cabling techniques.



RoHS Compliance



NEXCOM RoHS Environmental Policy and Status Update

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RoHS restricts the use of Lead (Pb) < 0.1% or 1,000ppm, Mercury (Hg) < 0.1% or 1,000ppm, Cadmium (Cd) < 0.01% or 100ppm, Hexavalent Chromium (Cr6+) < 0.1% or 1,000ppm, Polybrominated biphenyls (PBB) < 0.1% or 1,000ppm, and Polybrominated diphenyl Ethers (PBDE) < 0.1% or 1,000ppm.

In order to meet the RoHS compliant directives, NEXCOM has established an engineering and manufacturing task force to implement the introduction of green products. The task force will ensure that we follow the standard NEXCOM development procedure and that all the new RoHS components and new manufacturing processes maintain the highest industry quality levels for which NEXCOM are renowned.

The model selection criteria will be based on market demand. Vendors and suppliers will ensure that all designed components will be RoHS compliant.

How to recognize NEXCOM RoHS Products?

For existing products where there are non-RoHS and RoHS versions, the suffix "(LF)" will be added to the compliant product name.

All new product models launched after January 2006 will be RoHS compliant. They will use the usual NEXCOM naming convention.



Warranty and RMA

NEXCOM Warranty Period

NEXCOM manufactures products that are new or equivalent to new in accordance with industry standard. NEXCOM warrants that products will be free from defect in material and workmanship for 2 years, beginning on the date of invoice by NEXCOM. HCP series products (Blade Server) which are manufactured by NEXCOM are covered by a three year warranty period.

NEXCOM Return Merchandise Authorization (RMA)

- Customers shall enclose the "NEXCOM RMA Service Form" with the returned packages.
- Customers must collect all the information about the problems encountered and note anything abnormal or, print out any on-screen messages, and describe the problems on the "NEXCOM RMA Service Form" for the RMA number apply process.
- Customers can send back the faulty products with or without accessories (manuals, cable, etc.) and any components from the card, such as CPU and RAM. If the components were suspected as part of the problems, please note clearly which components are included. Otherwise, NEXCOM is not responsible for the devices/parts.
- Customers are responsible for the safe packaging of defective products, making sure it is durable enough to be resistant against further damage and deterioration during transportation. In case of damages occurred during transportation, the repair is treated as "Out of Warranty."
- Any products returned by NEXCOM to other locations besides the customers' site will bear an extra charge and will be billed to the customer.

Repair Service Charges for Out-of-Warranty Products

NEXCOM will charge for out-of-warranty products in two categories, one is basic diagnostic fee and another is component (product) fee.

Repair Service Charges for Out-of-Warranty Products

NEXCOM will charge for out-of-warranty products in two categories, one is basic diagnostic fee and another is component (product) fee.

System Level

- Component fee: NEXCOM will only charge for main components such as SMD chip, BGA chip, etc. Passive components will be repaired for free, ex: resistor, capacitor.
- Items will be replaced with NEXCOM products if the original one cannot be repaired. Ex: motherboard, power supply, etc.
- Replace with 3rd party products if needed.
- If RMA goods can not be repaired, NEXCOM will return it to the customer without any charge.

Board Level

- Component fee: NEXCOM will only charge for main components, such as SMD chip, BGA chip, etc. Passive components will be repaired for free, ex: resistors, capacitors.
- If RMA goods can not be repaired, NEXCOM will return it to the customer without any charge.



Warnings

Read and adhere to all warnings, cautions, and notices in this guide and the documentation supplied with the chassis, power supply, and accessory modules. If the instructions for the chassis and power supply are inconsistent with these instructions or the instructions for accessory modules, contact the supplier to find out how you can ensure that your computer meets safety and regulatory requirements.

Failure to complete all earth ground connection can cause EMI/EMC problem and could create shock hazard in the event of wiring insulation damage.

To avoid risk of electric shock, this equipment must only be connected to a supply mains with protective earth.

Do not modify this equipment without authorization of the manufacturer.

Cautions

Electrostatic discharge (ESD) can damage system components. Do the described procedures only at an ESD workstation. If no such station is available, you can provide some ESD protection by wearing an antistatic wrist strap and attaching it to a metal part of the computer chassis.



Safety Information

Before installing and using the device, note the following precautions:

- Read all instructions carefully.
- Do not place the unit on an unstable surface, cart, or stand.
- Follow all warnings and cautions in this manual.
- When replacing parts, ensure that your service technician uses parts specified by the manufacturer.
- Avoid using the system near water, in direct sunlight, or near a heating device.
- The load of the system unit does not solely rely for support from the rackmounts located on the sides. Firm support from the bottom is highly necessary in order to provide balance stability.
- The computer is provided with a battery-powered real-time clock circuit. There is a danger of explosion if battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Discard used batteries according to the manufacturer's instructions.
- Never open the equipment. For safety reasons, only qualified service personnel should open the equipment.



Danger of explosion if battery is incorrectly replaced. Replace with the same or equivalent type recommended by the manufacturer. Discard used batteries according to the manufacturer's instructions.

Installation Recommendations

Ensure you have a stable, clean working environment. Dust and dirt can get into components and cause a malfunction. Use containers to keep small components separated.

Adequate lighting and proper tools can prevent you from accidentally damaging the internal components. Most of the procedures that follow require only a few simple tools, including the following:

- A Philips screwdriver
- A flat-tipped screwdriver
- A grounding strap
- An anti-static pad

Using your fingers can disconnect most of the connections. It is recommended that you do not use needle-nose pliers to disconnect connections as these can damage the soft metal or plastic parts of the connectors.



Safety Precautions

- 1. Read these safety instructions carefully.
- 2. Keep this User Manual for later reference.
- 3. Disconnect this equipment from any AC outlet before cleaning. Use a damp cloth. Do not use liquid or spray detergents for cleaning.
- 4. For plug-in equipment, the power outlet socket must be located near the equipment and must be easily accessible.
- 5. Keep this equipment away from humidity.
- 6. Put this equipment on a stable surface during installation. Dropping it or letting it fall may cause damage.
- 7. The openings on the enclosure are for air convection to protect the equipment from overheating. DO NOT COVER THE OPENINGS.
- 8. Make sure the voltage of the power source is correct before connecting the equipment to the power outlet.
- 9. Place the power cord in a way so that people will not step on it. Do not place anything on top of the power cord. Use a power cord that has been approved for use with the product and that it matches the voltage and current marked on the product's electrical range label. The voltage and current rating of the cord must be greater than the voltage and current rating marked on the product.
- 10. All cautions and warnings on the equipment should be noted.

- 11. If the equipment is not used for a long time, disconnect it from the power source to avoid damage by transient overvoltage.
- 12. Never pour any liquid into an opening. This may cause fire or electrical shock.
- 13. Never open the equipment. For safety reasons, the equipment should be opened only by qualified service personnel.
- 14. If one of the following situations arises, get the equipment checked by service personnel:
 - a. The power cord or plug is damaged.
 - b. Liquid has penetrated into the equipment.
 - c. The equipment has been exposed to moisture.
 - d. The equipment does not work well, or you cannot get it to work according to the user's manual.
 - e. The equipment has been dropped and damaged.
 - f. The equipment has obvious signs of breakage.
- 15. Do not place heavy objects on the equipment.
- 16. The unit uses a three-wire ground cable which is equipped with a third pin to ground the unit and prevent electric shock. Do not defeat the purpose of this pin. If your outlet does not support this kind of plug, contact your electrician to replace your obsolete outlet.
- 17. CAUTION: DANGER OF EXPLOSION IF BATTERY IS INCORRECTLY REPLACED. REPLACE ONLY WITH THE SAME OR EQUIVALENT TYPE RECOMMENDED BY THE MANUFACTURER. DISCARD USED BATTERIES ACCORDING TO THE MANUFACTURER'S INSTRUCTIONS.



Medical Equipment Precautions

Intend Use Information

The product covered is an accessory intended for use with Medical Equipment to process data.

Disconnect Device Information

To fully disengage the power to the unit, please disconnect the power cord from the AC inlet.

Cleaning Information

Cleaning (Gently wipe it with a piece of soft dry cloth).

Dispose Information

Follow the national requirement to dispose unit.

Type of Protection Against Electric Shock

Class I equipment.

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Technical Support and Assistance

- 1. For the most updated information of NEXCOM products, visit NEXCOM's website at www.nexcom.com.
- 2. For technical issues that require contacting our technical support team or sales representative, please have the following information ready before calling:
 - Product name and serial number
 - Detailed information of the peripheral devices
 - Detailed information of the installed software (operating system, version, application software, etc.)
 - A complete description of the problem
 - The exact wordings of the error messages

Warning!

- 1. Handling the unit: Carry the unit with both hands and handle it with care.
- 2. Maintenance: To keep the unit clean, use only approved cleaning products or clean with a dry cloth.
- 3. CompactFlash: Turn off the unit's power before inserting or removing a CompactFlash storage card.
- 4. Replacement: If the components of the NISE 3640XXXXXX fail they must be replaced. Please contact the system reseller or vendor to purchase the replacement parts.



Conventions Used in this Manual



Warning: Informatio

Information about certain situations, which if not observed, can cause personal injury. This will prevent injury to yourself when performing a task.



Caution:

Information to avoid damaging components or losing data.



Note: Provides additional information to complete a task easily.



Safety Warning: This equipment is intended for installation in a Restricted Access Location only.



Information: Represents detailed information that can be found in the user manual.



USB 2.0



Hot Surface: Do not touch.



Power On



RJ45 Ethernet Port



VGA Monitor



Audio Mic-in





Conventions Used in this Manual Cont.



Dispose of in accordance with your country's requirement.



DC

Power Adapter AC Input

Power Adapter DC Input



The purpose of additional potential equalization is to equalize potentials between different metal parts that can be touched simultaneously, or to reduce differences of potential which can occur during operation between the bodies of medical electrical devices and conductive parts of other objects.

MC Potential Equalization Connector

The MC connector is specially shaped so as to prevent chance disconnection when used as intended, while allowing the lead to be removed without the need for tools.



Guidance and Manufacturer's Declaration – Electromagnetic Immunity

The models in NISE 3640M series are intended for use in the electromagnetic environment specified below. The customer or the user of the models in NISE 3640M series should assure that it is used in such an environment.

Immunity Test	IEC 60601 Test Level	Compliance Level
Conducted RF	3 Vrms	3 Vrms
IEC 61000-4-6	150 kHz to 80 MHz	5 01115
Radiated RF	3 V/m	3 V/m
IEC 61000-4-3	80 MHz to 2,5 GHz	3 V/III
Electrostatic discharge (ESD)	±6 kV contact	±2 kV ±4 kV ±6 kV contact
IEC 61000-4-2	±8 kV air	± 2 kV ± 4 kV ± 8 kV kV air
Electrical fast	±2 kV for power	±2 kV for power
transient/burst	supply lines	supply lines
	±1 kV for input/output	±1 kV for input/output
IEC 61000-4-4	lines	lines
Surge	±1 kV line(s) to line(s)	±1 kV line(s) to line(s)
IEC 61000-4-5	±2 kV line(s) to earth	± 2 kV line(s) to earth

Immunity Test	IEC 60601 Test Level	Compliance Level
interruptions and voltage	0 % UT (>95 % dip in UT)	0 % UT (>95 % dip in UT)
variations on power supply	for 0,5 cycle	for 0,5 cycle
input lines		
	40 % UT (60 % dip in UT)	40 % UT (60 % dip in UT)
IEC 61000-4-11	for 5 cycles	for 5 cycles
	70 % UT (30 % dip in UT)	70 % UT (30 % dip in UT)
	for 25 cycles	for 25 cycles
	0 % UT (>95 % dip in UT)	0 % UT (>95 % dip in UT)
	for 5 sec	for 5 sec
Power frequency	3 A/m	3 A/m
(50/60 Hz) magnetic field		5 7 111
NOTE: UT is the a.c. mains v	oltage prior to application of t	he test level.



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Package Contents

Before continuing, verify that the NISE 3640M package that you received is complete. Your package should have all the items listed in the following table.

ltem	Part Number	Description	Qty
1	4NCPM00203X00	Terminal Blocks 2P Phoenix Contact: 1803578	2
2	50311P0001X00	Price For Plastic Screw	1
3	50322P0002X00	Plastic Nut GIN LIAN:M6HW	1
4	60177A0311X00	NISB3640 Quick Reference Guide VER:A	1
5	6023344361X00	Cable EDI:231441090251-RS	1
6	60233POW33X00	DC Cord EDI:281040051051-RS	1
7	50311F0294X00	I Head Screw Long FEI:12x4 NYLOK NIGP	4
8	50311F0326X00	Flat Head Screw Long FEI:F3x5 NYLOK NI+HEAT TREATMENT	4
9	50311F0143X00	Flat Head Screw Long FEI:F#6-32x8	1
10	50311F0100X00	Round Head Screw w/Spring+Flat Washer Long FEI:P3x6L	2
11	50311F0315X00	Round Head Screw Long FEI:P6#32T T10 NYLOK	1
12	602DCD0654X00	NISE3640E CD Driver VER:1.0	1



Ordering Information

The following information below provides ordering information for NISE 3640M series.

• Barebone

NISE 3640M (P/N: 10J00364006X0)

- 3rd Generation Intel[®] Core™ i7 Fanless System with one PCIe x4 Expansion

NISE 3640M2 (P/N: 10J00364008X0)

- 3rd Generation Intel[®] Core[™] i7 Fanless System with two PCI Expansion

NISE 3640M2E (P/N: 10J00364009X0)

- 3rd Generation Intel[®] Core™ i7 Fanless System with one PCIe x4 Expansion and one PCI Expansion

NISE 3640ME2 (P/N: 10J00364007X0)

- 3rd Generation Intel[®] Core™ i7 Fanless System with two PCIe x4 Expansion

Power Supply SINPRO HPU101-108 24V/4.16A w/EN60601-1 (P/N: 7400100006X00)



Chapter 1: Product Introduction

Overview



Key Features

- Onboard 3rd generation Intel[®] Core[™] i7 BGA processor
- Mobile Intel[®] QM77 PCH
- Support 1x 2.5" SATA HDD or 2x SATA DOM
- 2x Display Port; 1x VGA; 1x DVI-D; 2x USB3.0; 2x USB2.0
- 4x Intel® 82574IT GbE LAN ports; support WoL, teaming and PXE



- 2x DB9 for RS232/422/485; 1x DB44 Serial Port for 4x RS232
- 1x Internal Mini-PCIe socket supports optional Wi-Fi or 3.5G module
- 1x CFast socket; 1xSIM card socket;
- Support +24VDC input; support ATX Power mode
- TUV/RH Certificate: EN60601-1:2006



Hardware Specifications

CPU Support

- Onboard 3rd generation Intel[®] Core[™] i7 BGA processor Core[™] i7-3517UE, Dual Core, 1.7GHz, 6M Cache
- Mobile Intel[®] QM77 PCH

Main Memory

- On-board 2x DDR3/DDR3L SO-DIMM, supports up to 8GB DDR3/DDR3L 1333/1600 SDRAM, with un-buffered and non-ECC
- Pre-install 4G Industrial Grade Memory as the manufacture configuration for shipment

Display Option

- Three Independent Display (only support on 3rd Generation Processor)
 - Two Display Port and 1x VGA
 - Two Display Port and 1x DVI-D
- Dual Independent Display
 - VGA and DVI-D
 - Display Port and VGA

I/O Interface-Front

- ATX power on/off switch
- HDD access/ Power status/ LAN status LEDs
- 2x USB3.0 (Blue color)
- 2x USB2.0
- 2x DisplayPort (Can be converted to DVI-D or HDMI via active cables)
- 1x CFast socket
- 1x SIM card socket
- 2x Antenna holes

I/O Interface-Rear

- 2x DB9 for RS232/422/485
- 1x DB44 for 4x RS232
- 4x Intel[®] 82574IT GbE LAN ports; support WoL, teaming and PXE
- 1x DB15 VGA port
- 1x DVI-D
- 1x Line-out and 1x Mic-in
- 2-pin Remote Power on/off switch
- +24VDC Input
- 1x Potential Equalization Connector (M6 Type)

Storage Device

- 1x 2.5" SATA HDD or 2x SATA DOM (support 90°C horizontal type only)
- 1x CFast socket

Expansion Slot

- NISE 3640E: One PCIe x4 Expansion Slot
 - Add-on card length: 169mm max.
 - Power consumption: 10W/slot max.
- NISE 3640ME2: Two PCIe x4 expansion
 - Add-on card length: One 169mm max. and One 240mm max.
 - Power consumption: 10W/slot max.
- NISE 3640M2: Two PCI expansion
 - Add-on card length: One 169mm max. and One 240mm max.
 - Power consumption: 10W/slot max.
- NISE 3640M2E: One PCI expansion and One PCIe x4 expansion
 - Add-on card length: 169mm max. for PCIe x4 and 240mm max. for PCI expansion
 - Power consumption: 10W/slot max.
- 2x Mini-PCle sockets (Top side Mini-PCle Socket support optional Wi-Fi or 3.5G module)



Power Requirements

Support +24VDC Input

Dimensions

 215mm (W) x 272mm (D) x 93mm (H) without wall mount bracket (8.5" x 10.7" x 3.7")

Construction

• Aluminum Chassis with fanless design

Environment

- Normal Operating Temperature:
 - Operating Temperature: -20°C to 45°C, ambient with air flow (According to IEC60068-2-1, IEC60068-2-2, IEC60068-2-14)
 - Relative Humidity: 10% ~ 90%, non-condensing Limits to be at 90% RH at max 40°C
 - Atmosphere Pressure: 700-1060hPa
- Transport and Storage Temperature:
 - Operating Temperature: -30°C to 85°C, ambient with air flow
 - Relative Humidity: 10% ~ 90%, non-condensing
 - Atmosphere Pressure: 500-1060hPa
- Shock protection:
 - HDD: 20G, half sine, 11ms, IEC60068-2-27
 - CFast: 50G, half sine, 11ms, IEC60068-2-27
- Vibration protection w/ HDD Condition
 - Random: 0.5Grms @ 5~500 Hz according to IEC60068-2-64
 - Sinusoidal: 0.5Grms @ 5~500 Hz according to IEC60068-2-6

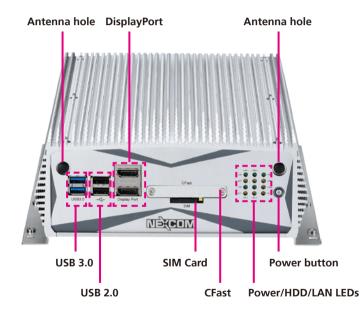
Certifications

- CE/FCC Class B
- TUV/RH Certificate: EN60601-1:2006



Knowing Your NISE 3640M

Front Panel



USB 3.0

Dual USB 3.0 ports to connect the system with USB 3.0/2.0 devices.

USB 2.0 Dual USB 2.0 ports to connect the system with USB 2.0 devices.

Antenna Hole Used to install external antennas.

DisplayPort Dual DisplayPort to connect the system with display devices.

SIM Used to insert a SIM card.

CFast Socket Used to insert a CompactFlash card.

Power/LAN LED

Indicates the power status and LAN activity of the system.

- The Power LED Color: Green
- The LAN LED Color: Green/Amber

HDD/CFast/RF LEDS

Indicates the HDD/CFast/RF activity of the system.

- The HDD/CFast/RF LED Color: Amber

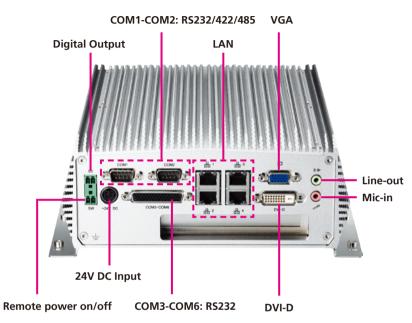
Power Switch

Press to power-on or power-off the system.

- Power off/Standby LED Status Color: Reddish Orange
- Power on LED Status Color: Blue



Rear Panel



Remote Power On/Off Used to connect a remote to power on/off the system.

Digital Output Support S3 Wake on LAN.

24V DC Input Used to plug a DC power cord.

COM1 and COM2 Two DB9 ports used to connect RS232/422/485 compatible devices.

COM3 to COM6 The DB44 port supports RS232 compatible serial devices.

LAN

Used to connect the system to a local area network.

VGA

Used to connect an analog VGA monitor.

DVI-D

Used to connect a digital LCD panel.

Line-out

Used to connect a headphone or a speaker.

Mic-in

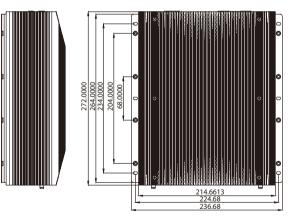
Used to connect an external microphone.

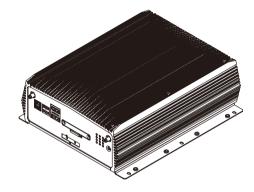
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Mechanical Dimensions NISE 3600M









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Chapter 2: Jumpers and Connectors

This chapter describes how to set the jumpers and connectors on the NISE 3640M motherboard.

Before You Begin

- Ensure you have a stable, clean working environment. Dust and dirt can get into components and cause a malfunction. Use containers to keep small components separated.
- Adequate lighting and proper tools can prevent you from accidentally damaging the internal components. Most of the procedures that follow require only a few simple tools, including the following:
 - A Philips screwdriver
 - A flat-tipped screwdriver
 - A set of jewelers screwdrivers
 - A grounding strap
 - An anti-static pad
- Using your fingers can disconnect most of the connections. It is recommended that you do not use needle-nosed pliers to disconnect connections as these can damage the soft metal or plastic parts of the connectors.
- Before working on internal components, make sure that the power is off. Ground yourself before touching any internal components, by touching a metal object. Static electricity can damage many of the electronic components. Humid environments tend to have less static electricity than

dry environments. A grounding strap is warranted whenever danger of static electricity exists.

Precautions

Computer components and electronic circuit boards can be damaged by discharges of static electricity. Working on computers that are still connected to a power supply can be extremely dangerous.

Follow the guidelines below to avoid damage to your computer or yourself:

- Always disconnect the unit from the power outlet whenever you are working inside the case.
- If possible, wear a grounded wrist strap when you are working inside the computer case. Alternatively, discharge any static electricity by touching the bare metal chassis of the unit case, or the bare metal body of any other grounded appliance.
- Hold electronic circuit boards by the edges only. Do not touch the components on the board unless it is necessary to do so. Don't flex or stress the circuit board.
- Leave all components inside the static-proof packaging that they shipped with until they are ready for installation.
- Use correct screws and do not over tighten screws.

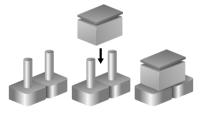


Jumper Settings

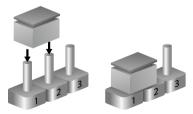
A jumper is the simplest kind of electric switch. It consists of two metal pins and a cap. When setting the jumpers, ensure that the jumper caps are placed on the correct pins. When the jumper cap is placed on both pins, the jumper is short. If you remove the jumper cap, or place the jumper cap on just one pin, the jumper is open.

Refer to the illustrations below for examples of what the 2-pin and 3-pin jumpers look like when they are short (on) and open (off).

Two-Pin Jumpers: Open (Left) and Short (Right)



Three-Pin Jumpers: Pins 1 and 2 are Short



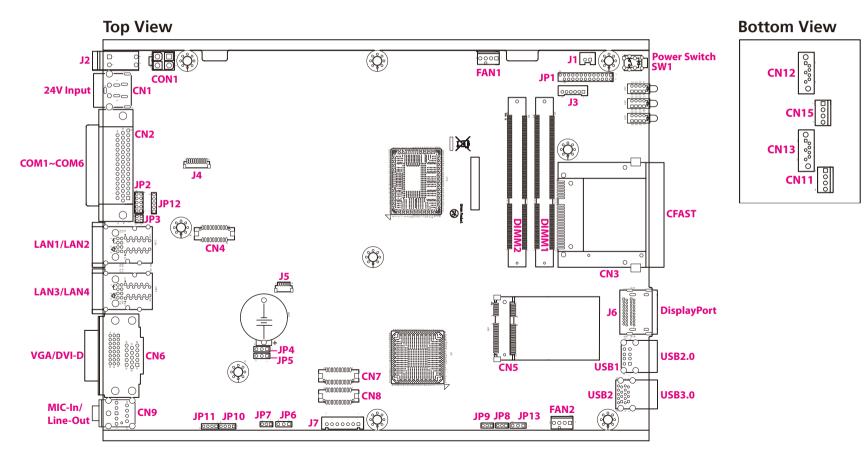
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Locations of the Jumpers and Connectors for NISB 3640

NISB 3640

The figures below are the top and bottom views of the NISB 3640 main board which is the main board used in the NISE 3640M. It shows the locations of the jumpers and connectors.



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Jumpers

ME Pin Header

Connector type: 1x3 3-pin header, 2.54mm pitch Connector location: JP5

COM4 RS232 RI# Pin Power Select

Connector type: 1x3 3-pin header, 2.0mm pitch Connector location: JP12

1 0 0 3

10000

Pin	Definition
1	SRTC_RST#_PU
2	SRTC_RST#
3	CLR_ME

Pin	Definition
1	VCC5_RI#
2	SP4_RI_T
3	+12V_RI#
4	SP4_RI_T
5	SP4_RI
6	NA



LVDS Power Pin Header

Connector type: 1x3 3-pin header, 2.54mm Connector location: JP6

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Pin	Definition
1	VCC3
2	VCCLCDIN
3	VCC5

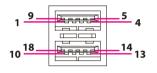
1-2 On: default



Connector Pin Definitions

External I/O Interfaces - Front Panel USB 3.0

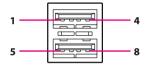
Connector type: Dual USB 3.0 ports Connector location: USB2



Pin	Definition	Pin	Definition
1	5VSB	2	USB_2N
3	USB_2P	4	GND
5	USB3_RX2_N	6	USB3_RX2_P
7	GND	8	USB3_TX2_N
9	USB3_TX2_P	10	5VSB
11	USB_3N	12	USB_3P
13	GND	14	USB3_RX3_N
15	USB3_RX3_P	16	GND
17	USB3_TX3_N	18	USB3_TX3_P
MH1	F_GND	MH2	F_GND
MH3	F_GND	MH4	F_GND

USB 2.0

Connector type: Dual USB 2.0 ports Connector location: USB1

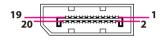


Pin	Definition	Pin	Definition
1	5VSB	2	USB2_8N
3	USB2_8P	4	GND
5	5VSB	6	USB2_9N
7	USB2_9P	8	GND
MH1	F_GND	MH2	F_GND
MH3	F_GND	MH4	F_GND



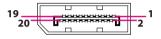
DisplayPort A

Connector type: DisplayPort Connector location: J6A



DisplayPort B

Connector type: DisplayPort Connector location: J6A



Pin	Definition	Pin	Definition
1	DPC_LANE0_P	2	GND_DP
3	DPC_LANE0_N	4	DPC_LANE1_P
5	GND_DP	6	DPC_LANE1_N
7	DPC_LANE2_P	8	GND_DP
9	DPC_LANE2_N	10	DPC_LANE3_P
11	GND_DP	12	DPC_LANE3_N
13	DPC_CONFIG1	14	DPC_CONFIG2
15	DPC_AUX_P	16	GND_DP
17	DPC_AUX_N	18	DPC_HPD
19	GND_DP	20	VCC3
MH1	F_GND	MH2	F_GND
MH3	F_GND	MH4	F_GND

Pin	Definition	Pin	Definition
1	DPD_LANE0_P	2	GND_DP
3	DPD_LANE0_N	4	DPD_LANE1_P
5	GND_DP	6	DPD_LANE1_N
7	DPD_LANE2_P	8	GND_DP
9	DPD_LANE2_N	10	DPD_LANE3_P
11	GND_DP	12	DPD_LANE3_N
13	DPD_CONFIG1	14	DPD_CONFIG2
15	DPD_AUX_P	16	GND_DP
17	DPD_AUX_N	18	DPD_HPD
19	GND_DP	20	VCC3
MH1	F_GND	MH2	F_GND
MH3	F_GND	MH4	F_GND



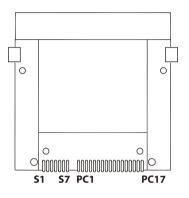
While using DisplayPort to HDMI cable or DisplayPort to DVI cable, the cable must be active type.



CFast

- -

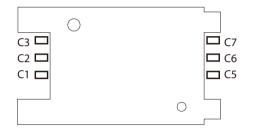
Connector type: Standard CFast connector Connector location: CN3



Pin	Definition	Pin	Definition
S1	GND	PC6	NC
S2	SATA_TXP3	PC7	GND
S3	SATA_TXN3	PC8	CFAST_LED1_C
S4	GND	PC9	CFAST_LED2_C
S5	SATA_RXN3	PC10	NC
S6	SATA_RXP3	PC11	NC
S7	GND	PC12	NC
PC1	CFAST_CDI	PC13	VCC3
PC2	GND	PC14	VCC3
PC3	NC	PC15	GND
PC4	NC	PC16	GND
PC5	NC	PC17	CFAST_CDO

SIM Card Connector

Connector location: IDE1



Pin	Definition	Pin	Definition
C1	UIM_PWR	C2	UIM_RESET
C3	UIM_CLK	C5	GND
C6	UIM_VPP	C7	UIM_DATA
SW1	NC	SW2	NC

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Power Switch

Connector location: SW1

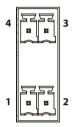


Pin	Definition	Pin	Definition
1	GND	2	PBT_PU
3	PBT_PU	4	GND
A1	PWR_SW_N	C1	PWR_SW_P
MH1	GND	MH2	GND



External I/O Interfaces - Rear Panel Remote Power on/off Switch

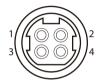
Connector type: 4-pin switch Connector location: J2



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DC-in Power Jack

Connector type: CompactFlash Type 2 Connector location: CN1



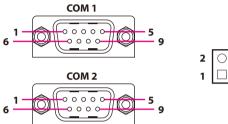
Pin	Definition	Pin	Definition
1	GND	2	PBT_PU
3	SLP_S3#	4	GND

Pin	Definition	Pin	Definition
1	VIN	2	VIN
3	GND	4	GND
5	GND	MH1	R_GND
MH2	R_GND	MH3	R_GND
MH4	R_GND		



COM 1 and COM 2 Ports

Connector type: DB-9 port, 9-pin D-Sub 2x10 20-pin header, 1.25mm pitch Connector location: CN4





Pin	Definition	Pin	Definition
1	SP1_DCD	2	SP2_DCD
3	SP1_TXD	4	SP2_TXD
5	SP1_RTS	6	SP2_RTS
7	SP1_RI	8	SP2_RI
9	COM56_GND	10	COM56_GND
11	SP1_RXD	12	SP2_RXD
13	SP1_DTR	14	SP2_DTR
15	SP1_DSR	16	SP2_DSR
17	SP1_CTS	18	SP2_CTS
19	COM56_GND	20	COM56_GND
MH1	COM56_GND	MH2	COM56_GND

COM1 Connector Pin Definition

RS232		RS422		RS485	
Pin	Definition	Pin	Definition	Pin	Definition
1	SP1_DCD	1	SP1_TX-	1	SP1_DATA-
2	SP1_RXD	2	SP1_TX+	2	SP1_DATA+
3	SP1_TXD	3	SP1_RX+	3	NC
4	SP1_DTR	4	SP1_RX-	4	NC
5	GND	5	GND	5	GND
6	SP1_DSR	6	SP1_RTS-	6	NC
7	SP1_RTS	7	SP1_RTS+	7	NC
8	SP1_CTS	8	SP1_CTS+	8	NC
9	SP3_RI	9	SP1_CTS-	9	NC

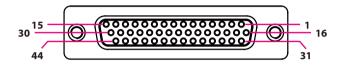
COM2 Connector Pin Definition

RS232		RS422		RS485	
Pin	Definition	Pin	Definition	Pin	Definition
1	SP2_DCD	1	SP2_TX-	1	SP2_DATA-
2	SP2_RXD	2	SP2_TX+	2	SP2_DATA+
3	SP2_TXD	3	SP2_RX+	3	NC
4	SP2_DTR	4	SP2_RX-	4	NC
5	GND	5	GND	5	GND
6	SP2_DSR	6	SP2_RTS-	6	NC
7	SP2_RTS	7	SP2_RTS+	7	NC
8	SP2_CTS	8	SP2_CTS+	8	NC
9	SP3_RI	9	SP2_CTS-	9	NC



COM3 to COM6

Connector type: DB-44 port, 44-pin D-Sub Connector location: CN2



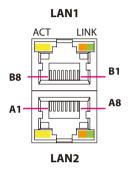
Pin	Definition	Pin	Definition
1	COM3_DCD	2	COM3_RXD
3	COM3_TXD	4	COM3_DTR
5	GND	6	COM3_DSR
7	COM3_RTS	8	COM3_CTS
9	COM3_RI	10	GND
11	COM4_DCD	12	COM4_RXD
13	COM4_TXD	14	COM4_DTR
15	GND	16	COM4_DSR
17	COM4_RTS	18	COM4_CTS
19	COM4_RI	20	GND
21	COM5_DCD	22	COM5_RXD
23	COM5_TXD	24	COM5_DTR
25	GND	26	COM5_DSR
27	COM5_RTS	28	COM5_CTS
29	COM5_RI	30	GND
31	COM6_DCD	32	COM6_RXD

Pin	Definition	Pin	Definition
33	COM6_TXD	34	COM6_DTR
35	GND	36	COM6_DSR
37	COM6_RTS	38	COM6_CTS
39	COM6_RI	40	GND
41	NC	42	NC
43	NC	44	NC
MH1	R_GND	MH2	R_GND



LAN1 and LAN2 Ports

Connector type: Dual RJ45 port with LEDs Connector location: COP1B (LAN1) and COP1A (LAN2)



Act	Status	
Flashing Yellow	Data activity	
Off	No activity	
Link	Status	
Link Steady Green	Status 1G network link	
	5 14 14 5	

LAN1

Pin	Definition	Pin	Definition
B1	MDIOP_LAN1	B2	MDION_LAN1
B3	MDI1P_LAN1	B4	MDI1N_LAN1
B5	MDI2P_LAN1	B6	MDI2N_LAN1
B7	MDI3P_LAN1	B8	MDI3N_LAN1
B9	VCC_LAN1	B10	GND
B11	3VSB	B12	LED_ACT#_LAN1
B13	LINK100#_LAN1	B14	LINK1G#_LAN1
MH4	R_GND	MH5	R_GND
MH6	R_GND		

LAN2

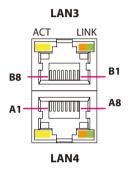
Pin	Definition	Pin	Definition
A1	MDIOP_LAN2	A2	MDION_LAN2
A3	MDI1P_LAN2	A4	MDI1N_LAN2
A5	MDI2P_LAN2	A6	MDI2N_LAN2
A7	MDI3P_LAN2	A8	MDI3N_LAN2
A9	VCC_LAN2	A10	GND
A11	3VSA	A12	LED_ACT#_LAN2
A13	LINK100#_LAN2	A14	LINK1G#_LAN2
MH4	R_GND	MH5	R_GND
MH6	R_GND		

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LAN3 and LAN4 Ports

Connector type: Dual RJ45 port with LEDs Connector location: COP2B (LAN3) and COP2A (LAN4)



	Act	Status	
	Flashing Yellow	Data activity	
	Off	No activity	
	Link	Status	
	Link Steady Green	Status 1G network link	

LAN3

Pin	Definition	Pin	Definition
B1	MDIOP_LAN3	B2	MDION_LAN3
B3	MDI1P_LAN3	B4	MDI1N_LAN3
B5	MDI2P_LAN3	B6	MDI2N_LAN3
B7	MDI3P_LAN3	B8	MDI3N_LAN3
B9	VCC_LAN3	B10	GND
B11	3VSB	B12	LED_ACT#_LAN3
B13	LINK100#_LAN3	B14	LINK1G#_LAN3
MH4	R_GND	MH5	R_GND
MH6	R_GND		

LAN4

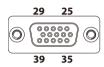
Pin	Definition	Pin	Definition
A1	MDIOP_LAN4	A2	MDION_LAN4
A3	MDI1P_LAN4	A4	MDI1N_LAN4
A5	MDI2P_LAN4	A6	MDI2N_LAN4
A7	MDI3P_LAN4	A8	MDI3N_LAN4
A9	VCC_LAN4	A10	GND
A11	3VSA	A12	LED_ACT#_LAN4
A13	LINK100#_LAN4	A14	LINK1G#_LAN4
MH4	R_GND	MH5	R_GND
MH6	R_GND		

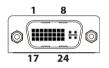
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VGA and DVI-D Connectors

Connector type: DB-15 port, 15-pin D-Sub (VGA) 24-pin D-Sub, 2.0mm-M-180 (DVI) Connector location: CN6B (VGA) and CN6A (DVI-D)





DVI-D

Pin	Definition	Pin	Definition
1	DVI_TDC2N	2	DVI_TDC2P
3	GND_DVI	4	NC
5	NC	6	DVI_DDC_CLK
7	DVI_DDC_DATA	8	NC
9	DVI_TDC1N	10	DVI_TDC1P
11	GND_DVI	12	NC
13	NC	14	VCC5
15	GND_DVI	16	DVI_HPD
17	DVI_TDC0N	18	DVI_TDC0P
19	GND_DVI	20	NC
21	NC	22	NC
23	DVI_CLK_P	24	DVI_CLK_N
MH1	R_GND	MH2	R_GND

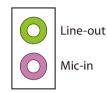
VGA

Pin	Definition	Pin	Definition
25	VGA_RED	26	VGA_GREEN
27	VGA_BLUE	28	GND_DVI
29	GND_DVI	30	VGA_DET
31	GND_DVI	32	GND_DVI
33	VCC5	34	GND_DVI
35	GND_DVI	36	DDC_DATA
37	VGA_HSYNC	38	VGA_VSYNC
39	DDC_CLK	MH3	R_GND
MH4	R_GND		



Audio Connectors

Connector type: 2x 3.5mm TRS Connector location: CN9A (Mic-in) and CN9B (Line-out)



Pin	Definition	Pin	Definition
1	GND_AUD	2	MIC_L
3	GND_AUD	4	MIC-JD1
5	MIC_R	MH1	R_GND
MH2	R_GND	MH3	R_GND
MH4	R_GND	22	LOUT_LBR
23	GND_AUD	24	FRONT-JD
25	LOUT_RBR	MH1	NC



Internal Connectors SIM Card Line-out Pin Header

Connector type: 1x3 3-pin header, 2.0mm Connector location: JP8

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SIM Card Mic-in Pin Header

Connector type: 1x3 3-pin header, 2.0mm Connector location: JP9

1 🗌 🔿 🔿 3

Pin	Definition	
1	LOUT_RL	
2	LOUT_RR	
3	ANGND	

Pin	Definition	
1	MIC_RL	
2	MIC_RR	
3	ANGND	



DC-in Power Connector

Connector type: 2x2 4-pin header Connector location: CON1

CMOS Pin Header

Connector type: 1x3 3-pin header, 2.54mm Connector location: JP4



$1 \square \bigcirc \bigcirc 3$

Pin	Definition
1	GND
2	GND
3	VIN
4	VIN

Pin	Definition	
1	RTC_RST#_PU	
2	RTC_RST#	
3	CLR_CMOS	



Reset JST Connector

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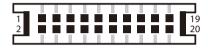
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Connector type: 1x2 2-pin header, 2.5mm pitch Connector location: J1

GND

LVDS Channel A Connector

Connector type: 2x10 20-pin header, 1.25mm pitch Connector location: CN7



Pin	Definition	Pin	Definition
1	LVDS_DDC_CLK	2	LVDS_DDC_DATA
3	PANEL1_VDD	4	LVDSA_DATA0
5	LVDSA_DATA3	6	LVDSA_DATA#0
7	LVDSA_DATA#3	8	PANEL1_VDD
9	GND	10	LVDSA_DATA1
11	LVDSA_CLK	12	LVDSA_DATA#1
13	LVDSA_CLK#	14	GND
15	GND	16	PANEL1_BACKLIGHT
17	LVDSA_DATA2	18	PANEL1_BACKLIGHT
19	LVDSA_DATA#2	20	GND
MH1	GND	MH2	GND

Pin	Definition
1	PM_RESET#_J

-

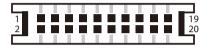


LVDS Channel B Connector

Connector type: 2x10 20-pin header, 1.25mm pitch Connector location: CN8

LVDS Backlight Connector

Connector type: 1x7 JST, 7-pin header, 2.5mm pitch Connector location: J7



	000000	
1	7	1

Pin	Definition	Pin	Definition
1	DDC_CLK	2	DDC_DATA
3	VDD	4	LVDSB_DATAP0
5	LVDSB_DATAP3	6	LVDSB_DATAN0
7	LVDSB_DATAN3	8	VDD
9	GND	10	LVDSB_DATAP1
11	LVDSB_CLKP	12	LVDSB_DATAN1
13	LVDSB_CLKN	14	GND
15	GND	16	PANEL1_BACKLIGHT
17	LVDSB_DATAP2	18	LVDSB_BACKLIGHT
19	LVDSB_DATAN2	20	GND
MH1	GND	MH2	GND

Pin	Definition	Pin	Definition
1	VCC5	2	PANEL1_BACKLIGHT
3	PANEL1_BACKLIGHT	4	L_BKLTCTL
5	GND	6	GND
7	LVDS_BKLT_EN		



Line-in 1 Pin Header

Connector type: 1x4 4-pin header, 2.5mm pitch Connector location: JP10

Line-in 2 Pin Header

1 0 0 0 4

Connector type: 1x4 4-pin header, 2.5mm pitch Connector location: JP11

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Pin	Definition	
1	LINE1-L	
2	R_GND	
3	LINE1-JD	
4	LINE1-R	

Pin	Definition
1	LINE2-L
2	R_GND
3	LINE2-JD
4	LINE2-R

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SATA3 Connector 1

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Connector type: Standard Serial ATAIII 7P (1.27mm, SATA-M-180) Connector location: CN13

SATA3 Connector 2

Connector type: Standard Serial ATAIII 7P (1.27mm, SATA-M-180) Connector location: CN12





Pin	Definition	Pin	Definition
1	GND	2	SATA_TXP1
3	SATA_TXN1	4	GND
5	SATA_RXN1	6	SATA_RXP1
7	GND		

Pin	Definition	Pin	Definition
1	GND	2	SATA_TXP0
3	SATA_TXN0	4	GND
5	SATA_RXN0	6	SATA_RXP0
7	GND		



SATA3 Power Connector 1

Connector type: 1x4 4-pin Wafer, 2.54mm pitch Connector location: CN11

SATA3 Power Connector 2

Connector type: 1x4 4-pin Wafer, 2.54mm pitch Connector location: CN15



Pin	Definition	
1	+12V	
2	GND	
3	GND	
4	VCC5	

1	4

Pin	Definition	
1	+12V	
2	GND	
3	GND	
4	VCC5	



GPS JST Connector

Connector type: 1x6 JST, 6-pin header, 1.00mm pitch Connector location: J5

USB 2.0 JST Connector

Connector type: 1x6 JST, 6-pin header, 2.00mm pitch Connector location: J3



Pin	Definition	Pin	Definition
1	3VSB	2	GPS_LED
3	COM6_TXD	4	COM6_RXD
5	GND	6	VCC3
MH1	GND	MH2	GND

Pin	Definition	Pin	Definition
1	5VSB	2	USB2_10N
3	USB2_10P	4	USB2_11N
5	USB2_11P	6	GND



PCIe x8 Slot

Connector type: PCIe x8 Slot Connector location: SLOT1

A	I A11	A12	A49
		B	······
B 1	I B11	B12	B49

Pin	Definition	Pin	Definition
A1	PCIE_PRSNT1	B1	+12V
A2	+12V	B2	+12V
A3	+12V	B3	+12V
A4	GND	B4	GND
A5	NC	B5	SMB_CLK
A6	NC	B6	SMB_DATA
A7	NC	B7	GND
A8	NC	B8	VCC3
A9	VCC3	B9	NC
A10	VCC3	B10	3VSB
A11	PLT_RST_CPU_PCIE#	B11	PCIE_WAKE#
A12	GND	B12	NC
A13	CLK_PEG_P	B13	GND
A14	CLK_PEG_N	B14	PEG_TXP0
A15	GND	B15	PEG_TXN0
A16	PEG_RXP0	B16	GND
A17	PEG_RXN0	B17	PRSNT2_1
A18	GND	B18	GND
A19	NC	B19	PEG_TXP0
A20	GND	B20	PEG_TXN0
A21	PEG_RXP1	B21	GND

Pin	Definition	Pin	Definition
A22	PEG_RXN1	B22	GND
A23	GND	B23	PEG_TXP0
A24	GND	B24	PEG_TXN0
A25	PEG_RXP2	B25	GND
A26	PEG_RXN2	B26	GND
A27	GND	B27	PEG_TXP0
A28	GND	B28	PEG_TXN0
A29	PEG_RXP3	B29	GND
A30	PEG_RXN3	B30	NC
A31	GND	B31	PRSNT2_2
A32	NC	B32	GND
A33	NC	B33	PEG_TXP0
A34	GND	B34	PEG_TXN0
A35	PEG_RXP4	B35	GND
A36	PEG_RXN4	B36	GND
A37	GND	B37	PEG_TXP0
A38	GND	B38	PEG_TXN0
A39	PEG_RXP5	B39	GND
A40	PEG_RXN5	B40	GND
A41	GND	B41	PEG_TXP0
A42	GND	B42	PEG_TXN0
A43	PEG_RXP6	B43	GND
A44	PEG_RXN6	B44	GND
A45	GND	B45	PEG_TXP0
A46	GND	B46	PEG_TXN0
A47	PEG_RXP7	B47	GND
A48	PEG_RXN7	B48	PRSNT2_3
A49	GND	B49	GND

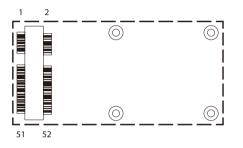
NEXCOM



Mini-PCle Connector

Connector location: CN5

-



Pin	Definition	Pin	Definition
1	MIC_R	2	3VSB
3	MIC_L	4	GND
5	LOUT_R	6	V1_5
7	LOUT_L	8	3VSB
9	GND	10	UIM_DATA
11	PCIE_MINI_CLK_N	12	UIM_CLK
13	PCIE_MINI_CLK_P	14	UIM_RESET
15	GND	16	UIM_VCCP
17	GND	18	GND
19	GND	20	3VSB
21	GND	22	PLT_RST
23	PCIE_MINI_RXN	24	3VSB
25	PCIE_MINI_RXP	26	GND

Pin	Definition	Pin	Definition
27	GND	28	V1_5
29	GND	30	SMB_CLK
31	PCIE_MINI_TXN	32	SMB_DATA
33	PCIE_MINI_TXP	34	GND
35	GND	36	USB_N
37	GND	38	USB_P
39	3VSB	40	GND
41	3VSB	42	WLAN_ACT
43	GND	44	WLAN_ACT
45	NA	46	WLAN_ACT
47	NA	48	V1_5
49	NA	50	GND
51	NA	52	3VSB



GPIO Pin Header

Connector type: 2x5 10-pin header, 2.00mm pitch Connector location: JP2

GPIO LED Pin Header

Connector type: 2x2 4-pin header, 2.00mm pitch Connector location: JP3



3	0	0	4
1		0	2

Pin	Definition	Pin	Definition
1	VCC5	2	GND
3	GPO24	4	GPI20
5	GPO25	6	GPI21
7	GPO26	8	GPI22
9	GPO27	10	GPI23

Pin	Definition
1	GPO24
2	GND
3	GPO25
4	GND



Smart Fan1 Connector

Connector type: 1x4 4-pin Wafer, 2.54mm pitch Connector location: FAN1

Smart Fan2 Connector

Connector type: 1x4 4-pin Wafer, 2.54mm pitch Connector location: FAN2



Pin	Definition
1	GND
2	+12V
3	FAN_TAC1
4	FAN_CTL1

1	4

Pin	Definition			
1	GND			
2	+12V			
3	FAN_TAC2			
4	FAN_CTL2			



External LED Pin Header

Connector type: 2x13 26-pin, 2.00mm pitch Connector location: JP1

Power/PSON Header

Connector type: 1x4 4-pin header, 3.81mm pitch Connector location: J2

|--|

Pin	Definition	Pin	Definition
1	PWR_LED_N	2	PWR_LED_P
3	PCH_SATA_LED#	4	LED_HDDP
5	CFAST_ACCESS	6	CFAST_LED_P
7	RF_LED_N	8	RF_LED_P
9	LAN1_LINK#	10	LAN1_LINKP
11	LED_ACT#_LAN1	12	LAN1_ACTP
13	LAN2_LINK#	14	LAN2_LINKP
15	LED_ACT#_LAN2	16	LAN2_ACTP
17	LAN3_LINK#	18	LAN3_LINKP
19	LED_ACT#_LAN3	20	LAN3_ACTP
21	LAN4_LINK#	22	LAN4_LINKP
23	LED_ACT#_LAN4	24	LAN4_ACTP
25	NC	26	NC

Pin	Definition	Pin	Definition
1	GND	2	PBT_PU
3	SLP_S3#	4	GND



80 Port

Connector type: 1x10 10-pin header, 1.00mm pitch Connector location: J4

External SMbus

Connector type: 1x3 3-pin header, 2.00mm pitch Connector location: JP7



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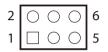
Pin	Definition	Pin	Definition
1	GND	2	PLT_RST_SIO#
3	CLK_PCI_P80	4	LPC_FRAME#
5	LPC_AD3	6	LPC_AD2
7	LPC_AD1	8	LPC_AD0
9	3VSB	10	3VSB
MH1	GND	MH2	GND

Pin	Definition		
1	SMB_CLK		
2	SMB_DATA		
3	GND		



Flash BIOS CON

Connector type: 2x3 6-pin, 2.00mm pitch Connector location: JFW1

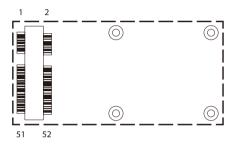


Pin	Definition	Pin	Definition
1	VSPI	2	GND
3	BIOS_SPI_CS#0	4	BIOS_SPI_CLK
5	BIOS_SPI_SO	6	BIOS_SPI_SI



Mini-PCle Slot

Connector location: CN14



Pin	Definition	Pin	Definition
1	PCIE_WAKE#	2	3VSB
3	NC	4	GND
5	NC	6	V1_5
7	PCIE_MINI2_CLKREQ#A	8	NC
9	GND	10	NC
11	CLK_PCIE_MINI2_N	12	NC
13	CLK_PCIE_MINI2_P	14	NC
15	GND	16	NC
17	NC	18	GND
19	NC	20	3VSB_MINI1
21	GND	22	PLT_RST_SP338#
23	PCIE_RXN2_MINI_PCIE	24	3VSB
25	PCIE_RXP2_MINI_PCIE	26	GND

Pin	Definition	Pin	Definition
27	GND	28	V1_5
29	GND	30	SMB_CLK
31	PCIE_TXN2_MINI_PCIE	32	SMB_DATA
33	PCIE_TXP2_MINI_PCIE	34	GND
35	GND	36	USB_1N
37	GND	38	USB_1P
39	3VSB_MINI1	40	GND
41	3VSB_MINI1	42	NA
43	GND	44	NA
45	NA	46	NA
47	NA	48	V1_5
49	NA	50	GND
51	NA	52	3VSB_MINI1



Chapter 3: System Setup

Mount the System to the Wall

The wallmount brackets provides a convenient and economical way of mounting the system on the wall.



- 1. The mounting holes are located at the bottom of the system. Secure the brackets on each side of the system using the provided mounting screws.
- 2. Now mount the system on the wall by fastening screws through the bracket's mounting holes.



Removing the Chassis Bottom Cover

Note: Installation for SATA Hard Drive and SATA DOM only



Prior to removing the chassis cover, make sure the unit's power is off and disconnected from the power sources to prevent electric shock or system damage.

- 1. With the bottom side of the chassis facing up, remove the mounting screw of the bottom cover and then put them in a safe place for later use.
- 2. Lift up the cover and remove it from the chassis.

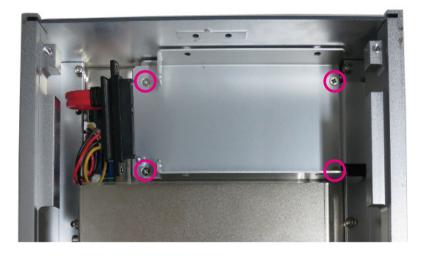




Installing a SATA Hard Drive

1. Remove 4 screws around the empty HDD bracket.

2. Use the provided screws to secure the drive in place.





•



- 3. Connect the SATA data/power cable and fasten the cable to HDD bracket by provided screw.
 - SATA drive/bracket

SATA data/power cable

4. Insert the HDD bracket onto the panel at a 45 degree angle, and gently slide the HDD bracket in place.



Panel



5. Connect the SATA data/power cable to the connector on the SATA drive then secure the HDD bracket to its original place.



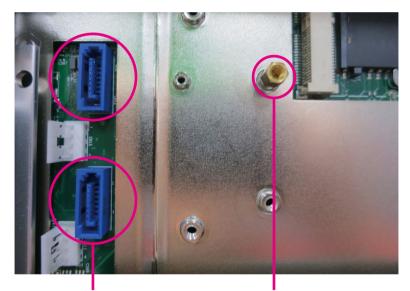
SATA drive/bracket

Screws



Installing a SATA DOM

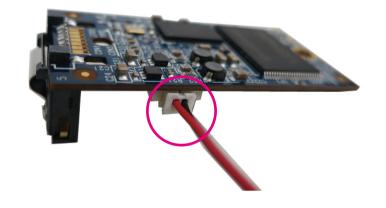
- 1. Remove the HDD bracket before installing a SATA DOM.
- 2. Locate the SATA connector on the board and fasten with the copper post included in the accessory package.



SATA Connector/ SATA Power Connector

Copper Post

3. Connect one side of power cable to the SATA DOM.

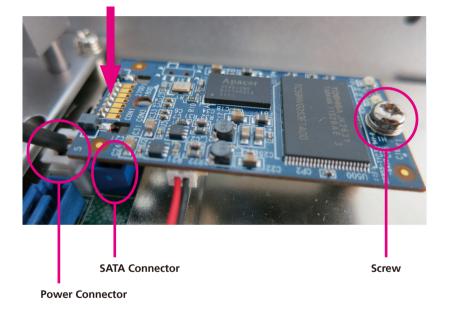




4. Install the SATA DOMM and connect the other side of SATA power cable to the SATA power connector.



The SATA DOMM is locked after installation. Be sure to push the lock when releasing.



5. Fasten the screw on the top of copper post.





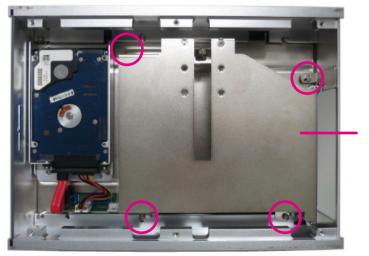


Installing a PCIe/PCI Expansion Card

Note:

NISE 3640E is equipped with one PCIe x4 expansion slot. NISE 3640E2 is equipped with two PCIe x4 expansion slot. NISE 3640P2 is equipped with two PCI expansion slot. NISE 3640P2E is equipped with one PCIe x4 expansion slot and one PCI expansion slot.

- 1. Remove the chassis bottom cover.
- 2. Remove screws of the riser bracket.

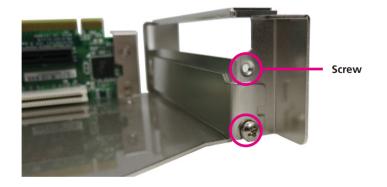




Note: Example shown is NISE 3640P2E



3. Remove screws on the expansion cover.



NEXCOM

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Note: Example shown is NISE 3640P2E

4. Insert PCIe/PCI expansion card and fasten the screw.



5. Secure the riser bracket to its original position.



Removing the Chassis Top Cover

1. Remove the mounting screw on the top cover and then put them in a safe place for later use.

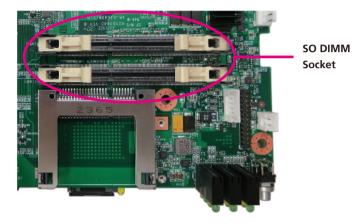


2. Lift up the cover and remove it from the chassis.

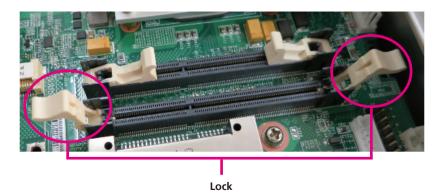


Installing a SO DIMM

1. Locate the SO DIMM socket.



2. Release the lock on the SO DIMM socket.



3. Insert the module into the socket at an 90 degree angle. Apply firm even pressure to each end of the module until it slips into the socket.



SO DIMM

4. While pushing the SO DIMM into the position, the lock will close automatically.



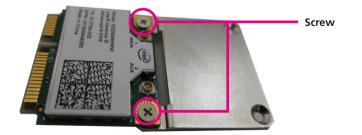


Installing a Wireless LAN Module (half-size)

1. Locate the Mini PCI Express slot on the board.



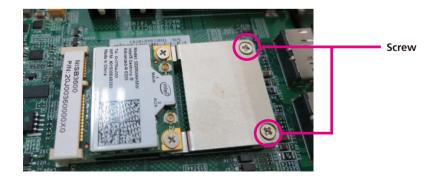
- Mini PCI Express Slot
- 2. Fasten the Wireless LAN module with the mini PCI express bracket.



3. Insert the wireless LAN module into the Mini PCI Express slot at a 45 degree angle until the gold-plated connector on the edge of the module completely disappears inside the slot.



4. Push the module down and then secure it with mounting screws.





Installing a Wireless LAN Module (full-size)

1. Locate the Mini PCI Express slot on the board.



Mini PCI Express Slot

2. Insert the wireless LAN module into the Mini PCI Express slot at a 45 degree angle until the gold-plated connector on the edge of the module completely disappears inside the slot.



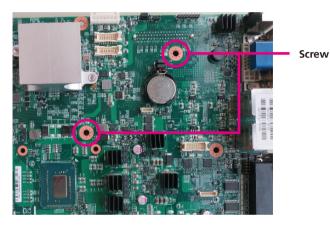
3. Push the module down and then secure it with mounting screws.



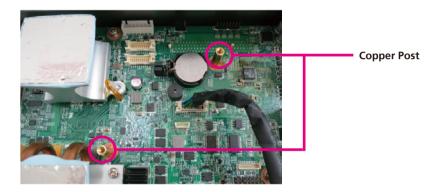


Installing a GPS Module

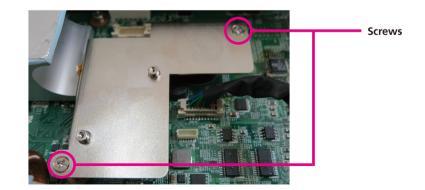
1. Locate the GPS module install location and remove the two screws on the board.



2. Fasten the copper post included in the accessory bag onto the screw holes.

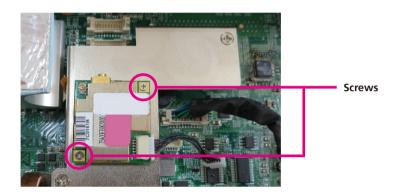


3. Secure the GPS bracket on the copper post.





4. Secure the GPS module to the bracket.



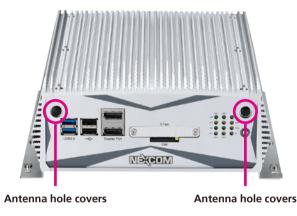
5. Connect the GPS cable



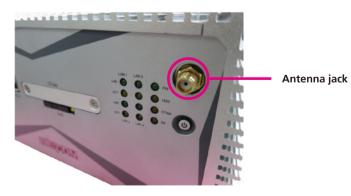


Installing Antennas

1. Remove the antenna hole covers located in the front panel.



2. Insert the antenna jack through the antenna hole.



3. Insert the 2 rings (ring 1 and ring2) onto the antenna jack.



4. Attach one end of the RF cable onto the module.



RF Cable



Installing a SIM Card

1. Locate the SIM card on the front panel.



3. Place the SIM card to the SIM card holder and secure it to the original position.



2. Push the yellow button to release the SIM card holder.



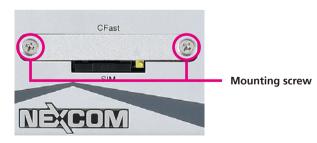


Installing a CompactFlash Card

1. The CompactFlash socket is located at the front side of the chassis.



2. Remove the mounting screws and cover of the CompactFlash socket.



- 3. Insert the CFast
- 4. Fasten the cover after installation.

Power ON Sequence on NISE 3640M

- 1. Connect Power Supply SINPRO HPU101-108 24V into AC Power Source. The AC Power Source needs to comply with following requirement:
 - 100-240V~47-63Hz, 1.2-0.5A
- 2. Connect Power Supply SINPRO HPU101-108 24V into NISE 3640M DC IN Mini-DIN Connector at rear panel.
- 3. Push the Power button on NISE 3640M.

Power OFF Sequence on NISE 3640M

- 1. Shut down the system by OS or by pushing the power button.
- 2. Disconnect the power cord from the AC inlet.



Chapter 4: BIOS Setup

This chapter describes how to use the BIOS setup program for the NISE 3640M. The BIOS screens provided in this chapter are for reference only and may change if the BIOS is updated in the future.

To check for the latest updates and revisions, visit the NEXCOM Web site at www.nexcom.com.tw.

About BIOS Setup

The BIOS (Basic Input and Output System) Setup program is a menu driven utility that enables you to make changes to the system configuration and tailor your system to suit your individual work needs. It is a ROM-based configuration utility that displays the system's configuration status and provides you with a tool to set system parameters.

These parameters are stored in non-volatile battery-backed-up CMOS RAM that saves this information even when the power is turned off. When the system is turned back on, the system is configured with the values found in CMOS.

With easy-to-use pull down menus, you can configure such items as:

- Hard drives, diskette drives, and peripherals
- Video display type and display options
- Password protection from unauthorized use
- Power management features

The settings made in the setup program affect how the computer performs. It is important, therefore, first to try to understand all the setup options, and second, to make settings appropriate for the way you use the computer.

When to Configure the BIOS

- This program should be executed under the following conditions:
- When changing the system configuration
- When a configuration error is detected by the system and you are prompted to make changes to the setup program
- When resetting the system clock
- When redefining the communication ports to prevent any conflicts
- When making changes to the Power Management configuration
- When changing the password or making other changes to the security setup

Normally, CMOS setup is needed when the system hardware is not consistent with the information contained in the CMOS RAM, whenever the CMOS RAM has lost power, or the system features need to be changed.



Default Configuration

Most of the configuration settings are either predefined according to the Load Optimal Defaults settings which are stored in the BIOS or are automatically detected and configured without requiring any actions. There are a few settings that you may need to change depending on your system configuration.

Entering Setup

When the system is powered on, the BIOS will enter the Power-On Self Test (POST) routines. These routines perform various diagnostic checks; if an error is encountered, the error will be reported in one of two different ways:

- If the error occurs before the display device is initialized, a series of beeps will be transmitted.
- If the error occurs after the display device is initialized, the screen will display the error message.

Powering on the computer and immediately pressing allows you to enter Setup. Another way to enter Setup is to power on the computer and wait for the following message during the POST:

TO ENTER SETUP BEFORE BOOT PRESS

Press the belkey to enter Setup:

Legends

Кеу	Function
← →	Moves the highlight left or right to select a menu.
	Moves the highlight up or down between sub¬menus or fields.
Esc	Exits the BIOS Setup Utility.
+	Scrolls forward through the values or options of the highlighted field.
-	Scrolls backward through the values or options of the highlighted field.
Tab Hereita	Selects a field.
F1	Displays General Help.
F2	Load previous values.
F3	Load optimized default values.
F4	Saves and exits the Setup program.
Enter,	Press <enter> to enter the highlighted sub¬menu</enter>



Scroll Bar

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When a scroll bar appears to the right of the setup screen, it indicates that there are more available fields not shown on the screen. Use the up and down arrow keys to scroll through all the available fields.

Submenu

When " \blacktriangleright " appears on the left of a particular field, it indicates that a submenu which contains additional options are available for that field. To display the submenu, move the highlight to that field and press \blacksquare .



BIOS Setup Utility

Once you enter the AMI BIOS Setup Utility, the Main Menu will appear on the screen. The main menu allows you to select from several setup functions and one exit. Use arrow keys to select among the items and press to accept or enter the submenu.

Main

The Main menu is the first screen that you will see when you enter the BIOS Setup Utility.

Main	Advanced	Chipset	Boot	Security	Save & Exit
BIOS Inform BIOS Vendor Core Version Compliancy Project Versio Build Date an	n		4.6.5.3 UEFI 2.3 N364-004	·	Set the Date. Use Tab to switch between Date elements.
Memory Info Memory Freq Total Memory DIMM#0 DIMM#2	uency		1600 Mh: 8192 MB 4096 MB 4096 MB	(DDR3) (DDR3)	
ME Firmward ME FW Versi ME Firmward ME Firmward System Date System Time	on e Mode	n	8.0.3.142' Normal M 1.5MB [Mon 03/ [13:27:32	Mode 25/2013]	→ → : Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Version 2.14.1219. Copyright (C) 2011 American Megatrends, Inc.

System Date

The date format is <day>, <month>, <date>, <year>. Day displays a day, from Monday to Sunday. Month displays the month, from January to December. Date displays the date, from 1 to 31. Year displays the year, from 1999 to 2099.

System Time

The time format is <hour>, <minute>, <second>. The time is based on the 24-hour military-time clock. For example, 1 p.m. is 13:00:00. Hour displays hours from 00 to 23. Minute displays minutes from 00 to 59. Second displays seconds from 00 to 59.



Advanced

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The Advanced menu allows you to configure your system for basic operation. Some entries are defaults required by the system board, while others, if enabled, will improve the performance of your system or let you set some features according to your preference.



Setting incorrect field values may cause the system to malfunction.

Aptio Setup Utility - Copyright (C) 2011 American Megatrends, Inc.					n Megatrends, Inc.
Main	Advanced	Chipset	Boot	Security	Save & Exit
 USB Cor Super IC Smart Fr H/W Mo 	ke Settings nfiguration onfiguration nfiguration O Configuration an Function	1			System ACPI Parameters. →: Select Screen 11: Select Item Enter: Select
	Version 2.1	4.1219. Copy	right (C) 20	11 American N	+/- Change Opt F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

ACPI Settings

This section is used to configure ACPI Settings.

Aptio Setup Utili Advanced	ty - Copyright (C) 2011 American M	egatrends, Inc.
ACPI Settings Enable Hibernation ACPI Sleep State	[Enabled] [S3 only(Suspend to]	Enables or Disables System ability to Hibernate (OS/S4 Sleep State). This option may be not effective with some OS.
	Enable Hibernation Disabled Enabled	
		 ← Select Screen ↑↓ Select Item +/- Change Field Tab Select Field F1 General Help F10 Save & Exit ESC Exit
Vanio-21112	19. Copyright (C) 2011 American Meg	atendo Ino

Enable Hibernation

Enables or disables system ability to hibernate (OS/S4 Sleep State). This option may not be effective with some OS.



ACPI Sleep State

ACPI Settings		Select the ACPI sleep state the system will enter when the SUS
Enable Hibernation ACPI Sleep State	[Enabled] [S3 only(Suspend to]	PEND button is pressed.
	ACPI Sleep State Suspend Disabled S1 only (CPU Stop Clock) S3 only (Suspend to RAM)	
		→←: Select Screen ↑↓: Select Item
		Enter: Select +/-: Change Opt.
		F1: General Help F2: Previous Values
		F3: Optimized Defaults F4: Save & Exit
		ESC: Exit

Select the highest ACPI sleep state the system will enter when the suspend button is pressed. The options are Suspend Disabled, S1 (CPU Stop Clock) and S3 (Suspend to RAM).

Wake System with Fixed Time

This section is used to configure the wake up function.

		Enable or disable System wake on alarm event. When enabled, System will wake on th hr::min::see specified
Dis	Wake system with Fixed Tim abled abled	e →←: Select Screen
		 †1: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Spave & Exit

Enables or disables the system's wake on alarm event. When enabled, the system will wake up on the specified time.

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CPU Configuration

This section is used to configure the CPU.

CPU Configuration Intel(R) Core(TM) CPU i5-3610ME CPU Signature Microcode Patch CPU Speed Processor Cores	306a9 10 1600 MHz 2	Enabled for Windows XP and Linux (OS optimized for Hyper-Threading Technology) and Disabled for other OS (OS not optimized for Hyper-Threading Technology). When Disabled only one thread per caabled core is enabled.
Intel HT Technology Intel VT-x Technology Intel SMX Technology 64-bit Hyper-threading Limit CPUID Maximum Intel Virtualization Technology	Supported Supported Supported Supported [Disabled] [Disabled]	→: Select Screen 1: Select Item Enter: Select +/-: Change Opt. FI: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

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Hyper Threading

Enables or disables hyper-threading technology.

Limit CPUID Maximum

The CPUID instruction of some newer CPUs will return a value greater than 3. The default is Disabled because this problem does not exist in the Windows series operating systems. If you are using an operating system other than Windows, this problem may occur. To avoid this problem, enable this field to limit the return value to 3 or lesser than 3.

Intel® Virtualization Technology

Enables or disables Intel® Virtualization technology.



SATA Configuration

This section is used to configure the SATA drives.

SATA Controller(s) SATA Mode Selection	[Enabled] [IDE]	Enable or disable SATA Device
Serial ATA Port 0 Software Preserve Serial ATA Port 1 Software Preserve Serial ATA Port 2 Software Preserve Serial ATA Port 3 Software Preserve	ST9160314AS (160.0 SUPPORTED Empty Unknown Empty Unknown 32GB SATA Flas (32.00 SUPPORTED	
		→→→: Select Screen ↑1: Select Item Enter: Select +/→: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

SATA Controller(s)

Enables or disables SATA device.

SATA Mode Selection

Configures the SATA as IDE, AHCI or RAID mode.

- IDE This option configures the Serial ATA drives as Parallel ATA physical storage device.
- RAID This option allows you to create RAID or Intel Matrix Storage configuration on Serial ATA devices.
- AHCI This option configures the Serial ATA drives to use AHCI (Advanced Host Controller Interface). AHCI allows the storage driver to enable the advanced Serial ATA features which will increase storage performance.

Serial ATA Port 0 to Serial ATA Port 3

Displays information on the SATA devices detected.



USB Configuration

This section is used to configure the USB.



Legacy USB Support

Enable Enables Legacy USB.

AutoDisables support for Legacy when no USB devices are connected.DisableKeeps USB devices available only for EFI applications.

USB3.0 Support

Enables or disables USB 3.0 controller support.

Super IO Configuration

This section is used to configure the serial ports.

Super IO Configuration		Set Parameters of Serial Por O (COMA)
Super 10 Chip > Serial Port 0 Configuration > Serial Port 1 Configuration > Serial Port 2 Configuration > Serial Port 3 Configuration > Serial Port 4 Configuration > Serial Port 5 Configuration	IT8783F	
		→ ←: Select Screen 1: Select Item Enter: Select +/: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Super IO Chip

Displays the Super I/O chip used on the board.



Serial Port 0 Configuration

This section is used to configure serial port 0.



Serial Port

Enables or disables the serial port.

Change Settings

Selects an optimal setting for the Super IO device.

Onboard Serial Port 1 Mode

Select this to change the serial port mode to RS232, RS422, RS485 or RS485 Auto.

Onboard Serial Port Max Baud Rate

Select this to change the max baud rate of the serial port.

Serial Port 1 Configuration

This section is used to configure serial port 1.

Serial Port 1 Configuration		Enable or Disable Serial Po (COM)
Serial Port Device Settings	[Enabled] IO=2F8h; IRQ=3;	
Change Settings Onboard Serial Port 1 Mode Onboard Serial Port Max Baud Rate	[IO=2F8h; IRQ=3;] [RS232] [115200 bps]	
		→→-: Select Screen 1: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Serial Port

Enables or disables the serial port.

Change Settings

Selects an optimal setting for the Super IO device.

Onboard Serial Port 1 Mode

Select this to change the serial port mode to RS232, RS422, RS485 or RS485 Auto.

Onboard Serial Port Max Baud Rate

Select this to change the max baud rate of the serial port.



Serial Port 2 Configuration

This section is used to configure serial port 2.



Serial Port

Enables or disables the serial port.

Change Settings

Selects an optimal setting for the Super IO device.

Onboard Serial Port Max Baud Rate

Select this to change the max baud rate of the serial port.

Serial Port 3 Configuration

This section is used to configure serial port 3.

Serial Port 3 Configuration		Enable or Disable Serial Pot (COM)
Serial Port Device Settings	[Enabled] IO=2E8h; IRQ=11;	
Change Settings Onboard Serial Port Max Baud Rate	[IO=2E8h; IRQ=11;] [115200 bps]	
		→+-: Select Screen 1: Select 1cm Enter: Select +/- Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Serial Port

Enables or disables the serial port.

Change Settings

Selects an optimal setting for the Super IO device.

Onboard Serial Port Max Baud Rate

Select this to change the max baud rate of the serial port.

.



Serial Port 4 Configuration

This section is used to configure serial port 4.



Serial Port

NEXCOM

Enables or disables the serial port.

Change Settings

Selects an optimal setting for the Super IO device.

Onboard Serial Port Max Baud Rate

Select this to change the max baud rate of the serial port.

Serial Port 5 Configuration

This section is used to configure serial port 5.

Serial Port 5 Configuration		Enable or Disable Serial Por (COM)
Serial Port Device Settings	[Enabled] IO=2E0h; IRQ=7;	
Change Settings Onboard Serial Port Max Baud Rate Onboard Serial Port 6 Mode	[IO=2E0h; IRQ=7;] [115200 bps] [RS232]	
		→→→ : Select Screen ↑1: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Serial Port

Enables or disables the serial port.

Change Settings

Selects an optimal setting for the Super IO device.

Onboard Serial Port Max Baud Rate

Select this to change the max baud rate of the serial port.

Onboard Serial Port 6 Mode

Select this to change the serial port mode to RS232, RS422, RS485 or RS485 Auto.



Onboard Serial Port 6 Mode



Onboard Serial Port 6 Mode

Select this to change the serial port mode to RS232 or GPS.

Smart Fan Function

This section is used to configure the fan's function.

Aptio Setup Uti Advanced	lity - Copyright (C) 2011 American	Megatrends, Inc.
PC Health Status		Smart Fan Mode Select
Smart Fan Mode		
	Smart Fan Mode Full on Mode Automatic Mode Disable Mode	→+-: Select Screen 1]: Select Itom Enter: Select +/-: Change Opt. FI: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit
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Smart Fan Mode

Selects the mode of the fan, the options are Full on Mode, Automatic Mode and Disable Mode.



H/W Monitor

This section is used to monitor hardware status such as temperature, fan speed and voltages.

Pc Health Status		
CPU temperature System temperature Fan1 Speed Fan2 Speed VCORE +3.3V +5V +12V	: +32C : +32C : N/A : N/A : +0.848 V : +3.328 V : +5.017 V : +11.932 V	→+-: Select Screen 11: Select Item
		Enter: Select +/c: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

CPU Temperature

Detects and displays the current CPU temperature.

System Temperature

Detects and displays the current system temperature.

Fan1 Speed

Detects and displays Fan1 speed.

Fan2 Speed Detects and displays Fan2 speed.

VCORE

Detects and displays the Vcore CPU voltage.

3.3V Detects and displays 3.3V voltage.

5V

Detects and displays 5V voltage.

12V

Detects and displays 12V voltage.



CPU PPM Configuration

This section is used to configure the Processor Power Management (PPM) configuration.

Advanced		Aptio Setup Utility - Copyright (C) 2011 American Megatrends, Inc.				
Auvanceu						
CPU PPM Configuration		Enable/Disable Intel SpeedStep				
EIST CPU C3 Report CPU C6 report CPU C7 report	[Disabled] [Disabled] [Disabled] [Disabled]					
		→→-: Select Screen 1]: Select Item Enter: Select +/-: Change Opt F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit				
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EIST

Enables or disables Intel® SpeedStep.

CPU C3 Report Enables or disables C3 report to the operating system.

CPU C6 Report Enables or disables C6 report to the operating system.

CPU C7 Report

Enables or disables C7 report to the operating system.



Chipset

This section gives you functions to configure the system based on the specific features of the chipset. The chipset manages bus speeds and access to system memory resources.

Aptio Setup Utility - Copyright (C) 2011 American Megatrends, Inc.					atrends, Inc.	
Main	Advanced	Chipset	Boot	Security	Sav	e & Exit
	Configuration Agent (SA) Con	figuration				PCH Parameters
						→→- Select Screen 1): Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit
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PCH-IO Configuration

PCH-IO parameters.

System Agent (SA) Configuration

System Agent (SA) parameters.

PCH-IO Configuration

This section is used to configure PCH-IO configuration.

- Aptio Setup Utility Chips	an Megatrends, Inc.	
 USB Configuration PCH Azalia Configuration BIOS Security Configuration LAN1 Controller LAN2 Controller LAN3 Controller LAN4 Controller Restore AC Power Loss 	[Enabled] [Enabled] [Enabled] [Enabled] [Power On]	USB Configuration settings
		→→→: Select Screen 1; Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit
		F3: Optimized Defaults F4: Save & Exit

LAN1 to LAN4 Controller

Enables or disables the onboard controllers for LAN1 to LAN4.



USB Configuration



EHCI1 and EHCI2

NEXCOM

Enables or disables the Enhanced Host Controller Interface (USB 2.0), one EHCI controller must always be enabled.

PCH Azalia Configuration

PCH Azalia Configuration	Control Detection of the Azalia device.
	Disabled – Azalia will be unconditionally disabled Enabled – Azalia will be unconditionally Enabled Auto – Azalia will be enabled i present, disabled otherwise.
	→: Select Screen 1: Select Hem Enter, Select +/- Change Opt F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Azalia

Control Detection of the Azalia device.

Disabled	Azalia will be unconditionally disabled.
Enabled	Azalia will be unconditionally Enabled.



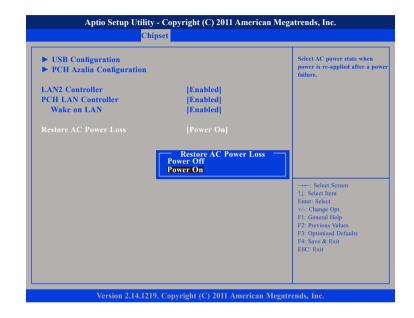
BIOS Security Configuration

BIOS Security Configuration	1	Enable or disable bytes 38h-3Fh in the upper and lower 128-byte
RTC RAM Leok		bank of RTC RAM lockdown.
		: Select Screen 1: Select Hem Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

RTC RAM Lock

Enables or disables bytes 38h-3Fh in the upper and lower 128-byte bank of RTC RAM lockdown.

Restore AC Power Loss



Restore AC Power Loss

- Off When power returns after an AC power failure, the system's power is off. You must press the Power button to power-on the system.
- On When power returns after an AC power failure, the system will automatically power-on.



System Agent (SA) Configuration

This section is used to configure the System Agent (SA) configuration.



VT-d

Enables or disables VT-d function on MCH.

Graphics Configuration

Configures the graphic chip settings.

NB PCIe Configuration

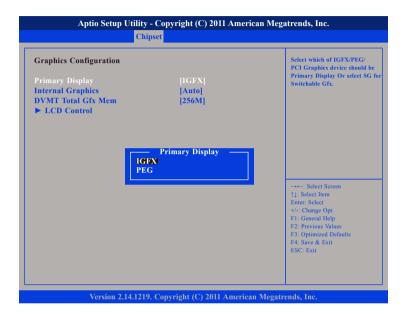
Configures the NB PCI Express settings.

Graphics Configuration

Graphics Configuration		Select which of IGFX/PEG/ PCI Graphics device should be
Primary Display Internal Graphics DVMT Total Gfx Mem ► LCD Control	[IGFX] [Auto] [256M]	Primary Display Or select SG fo Switchable Gfx.
		→←: Select Screen
		Enter: Select +/-: Change Opt.
		F1: General Help F2: Previous Values
		F3: Optimized Defaults F4: Save & Exit
		ESC: Exit



Primary Display



Select which of IGFX/PEG/PCI graphics device should be primary display or select SG for switchable GFx.

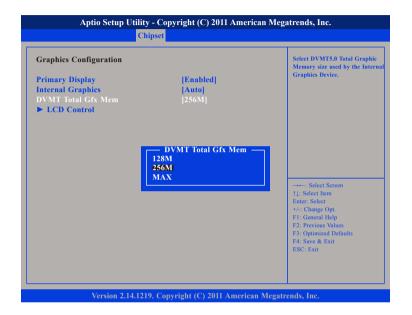
Internal Graphics



Keep IGD enabled based on the setup options.



Internal Graphics



Selects DVMT5.0 Total Graphic Memory size used by the Internal Graphics Device.



LCD Control

LCD Control		Select the Video Device which will be activated during POST.
Primary IGFX Boot Display	[CRT]	This has no effect if external graphics present. Secondary boot
Secondary IGFX Boot Display	[Disabled]	display selection will appear
LCD Panel Type Active LFP	[1024x768 LVDS]	based on your selection. VGA modes will be supported
Panel Color Depth	[No LVDS] [18 Bit]	only on primary display
		→ ←: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

	DP	DP	Other ports	DP	DP	Other ports
Mode		Extended			Clone	
3-display	DP	DP	VGA	DP	DP	VGA
	1920 x 1080					
3-display	DP	DP	DVI	DP	DP	DVI
	1920 x 1080					
3-display	DP	DP	LVDS	DP	DP	LVDS
	1920 x 1080	1920 x 1080	1280 x 1024	1920 x 1080	1920 x 1080	1280 x 1024



Primary IGFX Boot Display

LCD Control		Select the Video Device which will be activated during POST. This has no effect if external
Primary IGFX Boot Display	[CRT]	graphics present. Secondary boo
Secondary IGFX Boot Display	[Disabled] [1024x768 LVDS]	display selection will appear based on your selection.
LCD Panel Type Active LFP	[1024x768 LVDS] [No LVDS]	VGA modes will be supported
Panel Color Depth	[18 Bit]	only on primary display
	LFP DP2 DP1	→→→: Select Screen ↑1: Select Item Enter: Select ↓/-: Change Opt F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Select the video device which will be activated during POST. Has no effect if external graphics is present. Secondary boot display selection will appear based on your selection. VGA modes will be supported only on primary display.

Secondary IGFX Boot Display

		Select Secondary Display Devic
Primary IGFX Boot Display Secondary IGFX Boot Display LCD Panel Type Active LFP Panel Color Depth	[CRT] [Disabled] [1024x768 LVDS] [No LVDS] [18 Bit]	
	Secondary IGFX Boot Displa sabled P	→←: Select Screen
		↑↓: Select Item

Select the secondary display device.



LCD Panel Type

-

LCD Control Primary IGFX Boot Display Secondary IGFX Boot Display LCD Panel Type	[CRT] [Disabled] [1024x768	LVDSI	Select LCD panel used by Internal Graphics Device by selecting the appropriate setur item.
Active LFP Panel Color Depth	Primary IGFX Bo 640x480 800x600 1024x768 1280x1024 1600x1200 1366x768 1680x1050 1920x1200 1600x900 1280x800 1920x1080	ot Display LVDS LVDS LVDS LVDS LVDS LVDS LVDS LVDS	→+

Select the LCD panel used by the internal graphics device by selecting the appropriate setup item.

Active LFP

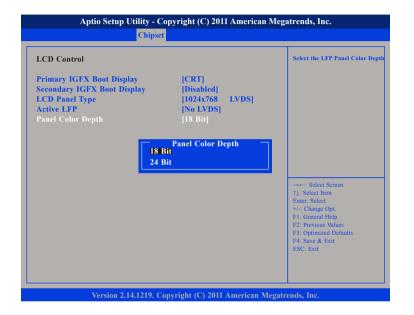
LCD Control		Select the Active LFP Configuration.
Primary IGFX Boot Display	[CRT]	No LVDS: VBIOS does not enable LVDS.
Secondary IGFX Boot Display	[Disabled]	Int-LVDS: VBIOS enables LVD
LCD Panel Type	[1024x768 LVDS]	driver by Integrated encoder. SDVO LVDS: VBIOS enables
Active LFP	[No LVDS]	LVDS driver by SDVO encoder.
Panel Color Depth	[18 Bit]	eDP Port-A: LFP Driven by
		Int-DisplayPort encoder from Port-A.
	Active LFP	
	No LVDS	
	Int-LVDS	→←: Select Screen
		↑1: Select Item Enter: Select
		+/-: Change Opt.
		F1: General Help
		F2: Previous Values F3: Optimized Defaults
		F4: Save & Exit

Select the Active LFP configuration.

No LVDS	VBIOS does not enable LVDS.
Int-LVDS	VBIOS enables LVDS driver by Integrated encoder.



Panel Color Depth



Select the LFP Panel Color Depth.

NB PCIe Configuration

This section is used to configure Northbridge PCI Express settings.

NB PCIe Configuration		Configure PEG0 B0:D1:F0 Gen1-Gen3. IVB maximum Ger
PEG0 PEGO - Gen X	Not Present [Auto]	SNB maximum Gen2.
PEGO - Gell A	Not Present	
PEG1 - Gen X	[Auto]	
Enable PEG	[Enabled]	
		→←: Select Screen
		↑↓: Select Item Enter: Select
		+/-: Change Opt.
		F1: General Help F2: Previous Values
		F3: Optimized Defaults
		F4: Save & Exit

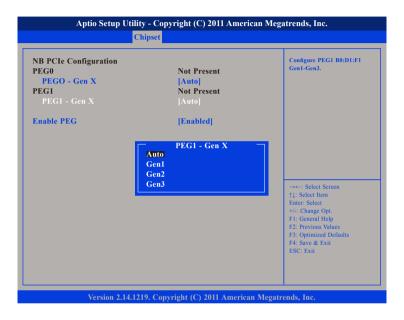


PEG0 - Gen X



Configure PEG0 B0:D1:F0 Gen1-Gen3, IVB maximum Gen3, SNB maximum Gen2.

PEG1 - Gen X



Configure PEG1 B0:D1:F1 Gen1-Gen3.



Enable PEG

NB PCIe Configuration PEG0 PEGO - Gen X	Not Present	
PECO Con V		
TEGO - Gell A	[Auto]	
PEG1	Not Present	
PEG1 - Gen X	[Auto]	
Enable PEG		
		→←: Select Screen
		†↓: Select Item
		Enter: Select +/-: Change Opt.
		F1: General Help
		F2: Previous Values
		F3: Optimized Defaults
		F4: Save & Exit

Enables or disables the PEG slot.



Boot

This section is used to configure the boot features.



Quiet Boot

Enabled Disabled Displays OEM logo instead of the POST messages. Displays normal POST messages.

Launch PXE OpROM Policy

Controls the execution of UEFI and legacy PXE OpROM.

Boot Option Priorities

Adjust the boot sequence of the system. Boot Option #1 is the first boot device that the system will boot from, next will be #2 and so forth.

Boot Option #1

Aptio Setup Utility	- Copyright (C) 2011 American Meg	atrends, Inc.
Main Advanced Chi	pset Boot Security Sav	/e & Exit
Quiet Boot Launch PXE OpROM policy	[Disabled] [Disabled]	Sets the system boot order
Boot Option Priorities Boot Option #1	[SATA PM: ST916031]	
Hard Drive BBS Priorities		
	Boot Option #1 SATA PM: ST9160314AS Disabled	→→-: Select Screen 1J: Select Item Enter: Select 4/< Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit
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Sets the system boot order.



Hard Drive BBS Priorities Boot Option #1

Aptio Setup Utility - Copyright (C) 2011 American Megatrends, Inc.		
	Boot	
Boot Option #1 Boot Option #2	[SATA PM: ST916031] Sets the system boot order [SATA SS: 32GB SATA]	
	Boot Option #1 SATA PM: ST9160314AS SATA SS: 32GB SATA Flash Driv Disabled	
	→+: Select Screen ↑1: Select Hem Enter. Select +/: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit	
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Sets the first legacy device to boot from.

Boot Option #2

		Coto dha anntana ha at andara
300t Option #1 300t Option #2	[SATA PM: ST916031] [SATA SS: 32GB SATA]	Sets the system boot order
	Boot Option #2 SATA PM: ST9160314AS SATA SS: 32GB SATA Flash Driv Disabled	
		→ Select Screen ↑↓: Select Hem Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Sets the second legacy device to boot from.



Security

Main Advanced	Chipset	Boot	Security	Save & Exit
Password Description If ONLY the Administrat then this only limits acce only asked for when ente If ONLY the User's pass- is a power on password a boot or enter Setup. In S have Administrator right	ss to Setup an ering Setup. word is set, th and must be e etup the User is.	nd is nen this entered to		Set Administrator Password
in the following range:	st be			
Minimum length Maximum Administrator Password User Password		3 20		→++: Select Screen 1]: Select Item Ente: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Administrator Password

Select this to reconfigure the administrator's password.

User Password

Select this to reconfigure the user's password.

Save & Exit



Save Changes and Reset

To save the changes and reset, select this field then press <Enter>. A dialog box will appear. Confirm by selecting Yes.

Discard Changes and Reset

To exit the Setup utility without saving the changes, select this field then press <Enter>. You may be prompted to confirm again before exiting.

Load Optimized Defaults

To restore the BIOS to default settings, select this field then press <Enter>. A dialog box will appear. Confirm by selecting Yes.



Appendix A: Power Consumption

Test Configuration

System Configuration	Sys#1
Chassis	CHASSIS NISE3600 VER:A
CPU	Intel [®] Core™ i7-3517UE Processor (4M Cache, up to 2.80 GHz)
Memory	Transcend 4GB DDR3 1600MHz SODIMM (TS512MSK64V6N) x2
CPU board	N/A
Mother board	NISB3640 REV:A
HDD	HDD 2.5" SATA Automotive HITACHI:HEJ421080G9SA00 (-30° to 85° C)
FDD	N/A
CD-ROM	N/A
CFast	Apacer CFast 32GB
Power Supply	POWER SUPPLY HPU101-108 24V/4.16A w/EN60601-1
Add-on Card	N/A
CPU Cooler	NISE3640 CPU HEATSINK SHYUNG SHUHN
System FAN	N/A
Keyboard	Microsoft Wired Keyboard 600
Mouse	Microsoft Basic Optical Mouse
Monitor	ASUS VS228



Power Consumption Management

Purpose

The purpose of the power consumption test is to verify the power dissipation of system, and the loading of power supply.

Test Equipment

PROVA CM-07 AC/DC CLAMP METER

Device Under Test

DUT: sys#1/

Test Procedure

- 1. Power up the DUT, boot into Windows 7 x64 Ultimate
- 2. Entering standby mode (HDD power down)
- 3. Measure the power consumption and record it.
- 4. Run Burn-in test program to apply 100% full loading
- 5. Measure the power consumption and record it.

Test Data

	Sys #1 (Disabled Turbo Boot)
	+24V
Full-Loading Mode	1.61A
Total	38.64W
Standby S3Mode	0.08A
Total	1.92W



Appendix B: GPI/O Programming Guide

GPI/O (General Purpose Input/Output) pins are provided for custom system design. This appendix provides definitions and its default setting for the ten GPI/O pins. The pin definition is shown in the following table:

Pin	GPI/O mode	PowerOn Default	Address	Pin	GPI/O mode	PowerOn Default	Address
1	VCC	-	-	2	GND	-	-
3	GPO0	Low	A04h (Bit4)	4	GPI0	High	A04h (Bit0)
5	GPO1	Low	A04h (Bit5)	6	GPI1	High	A04h (Bit1)
7	GPO2	Low	A04h (Bit6)	8	GPI2	High	A04h (Bit2)
9	GPO3	Low	A04h (Bit7)	10	GPI3	High	A04h (Bit3)

Control the GPO pin (3/5/7/9) level from I/O port A04h bit (4/5/6/7). The bit is Set/Clear indicated output High/Low.

#

GPO0_HI; GPO1_LO; GPO2_HI; GPO3_LO;



GPIO programming sample code

#define GPIO_PORT	0xA04
#define GPO0	(0x01 << 4)
#define GPO1	(0x01 << 5)
#define GPO2	(0x01 << 6)
#define GPO3	(0x01 << 7)

#define GPO0_HI	outportb(GPIO_PORT, GPO0)
#define GPO0_LO	outportb(GPIO_PORT, 0x00)
#define GPO1_HI	outportb(GPIO_PORT, GPO1)
#define GPO1_LO	outportb(GPIO_PORT, 0x00)
#define GPO2_HI	outportb(GPIO_PORT, GPO2)
#define GPO2_LO	outportb(GPIO_PORT, 0x00)
#define GPO3_HI	outportb(GPIO_PORT, GPO3)
#define GPO3_LO	outportb(GPIO_PORT, 0x00)
void main(void)	
<i>,</i>	



Appendix C: Watchdog Timer Setting

ITE8783 WatchDog Programming Guide

#define SUPERIO_PORT0x2E#define WDT_SET0x72#define WDT_VALUE0x73

void main(void)

#Enter SuperIO Configuration outportb(SUPERIO_PORT, 0x87); outportb(SUPERIO_PORT, 0x01); outportb(SUPERIO_PORT, 0x55); outportb(SUPERIO_PORT, 0x55);

Set LDN

outportb(SUPERIO_PORT, 0x07); outportb(SUPERIO_PORT+1,0x07);

Set WDT setting

outportb(SUPERIO_PORT, WDT_SET); outportb(SUPERIO_PORT+1, 0xC0); #Use the second #Use the minute, change value to 0x40

Set WDT sec/min

outportb(SUPERIO_PORT, WDT_VALUE);
outportb(SUPERIO_PORT+1, 0x05);

#Set 5 seconds